

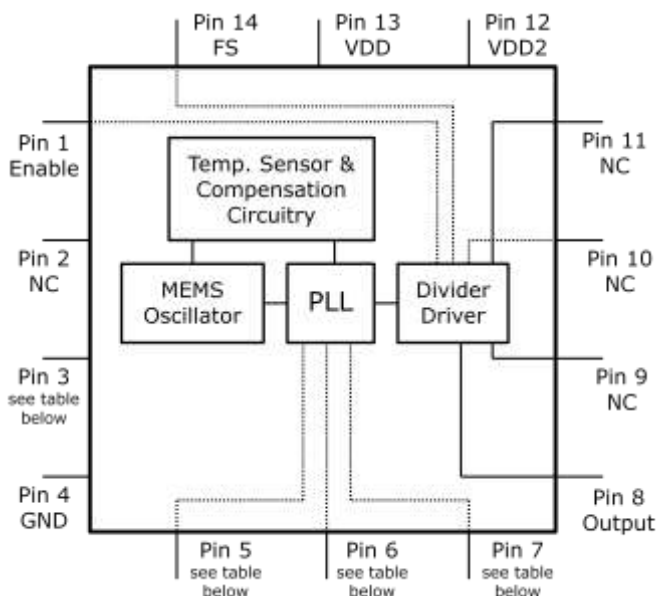
## Low-Jitter I<sup>2</sup>C/SPI Programmable CMOS Oscillator

### General Description

The DSC2110 and DSC2210 series of programmable, high-performance CMOS oscillators utilize a proven silicon MEMS technology to provide excellent jitter and stability while incorporating high output frequency flexibility and drive strength control. DSC2110 and DSC2210 allow the user to modify the frequency and CMOS drive strength using I<sup>2</sup>C or SPI interface, respectively. User can also select from two pre-programmed default output frequencies using the control pin.

DSC2110 and DSC2210 are packaged in 14-pin 3.2x2.5 mm QFN packages and available in temperature grades from Ext. Commercial to Automotive.

### Block Diagram



Pin #	DSC2110 (I <sup>2</sup> C)	DSC2210 (SPI)
3	NC	SCLK
5	SDA	MOSI
6	SCL	MISO
7	CS_bar	SS

### Features

- **Low RMS Phase Jitter: <1 ps (typ)**
- **High Stability:  $\pm 10$ ,  $\pm 25$ ,  $\pm 50$  ppm**
- **Wide Temperature Range**
  - Automotive: -55° to 125° C
  - Ext. Industrial: -40° to 105° C
  - Industrial: -40° to 85° C
  - Ext. commercial: -20° to 70° C
- **High Supply Noise Rejection: -50 dBc**
- **I<sup>2</sup>C/SPI Programmable Freq & Drive**
- **Short Lead Times: 2 Weeks**
- **Wide Freq. Range:**
  - CMOS Output: 2.3 to 170 MHz
- **Miniature Footprint of 3.2x2.5mm**
- **Excellent Shock & Vibration Immunity**
  - Qualified to MIL-STD-883
- **High Reliability**
  - 20x better MTF than quartz oscillators
- **Supply Range of 2.25 to 3.6 V**
- **Lead Free & RoHS Compliant**

### Applications

- **Consumer Electronics**
- **Storage Area Networks**
  - SATA, SAS, Fibre Channel
- **Passive Optical Networks**
  - EPON, 10G-EPON, GPON, 10G-PON
- **Ethernet**
  - 1G, 10GBASE-T/KR/LR/SR, and FCoE
- **HD/SD/SDI Video & Surveillance**
- **PCI Express**

## Pin Description

Pin No.	Pin Name	Pin Type	Description
1	Enable	I	Enables outputs when high and disables when low
2	NC	NA	Leave unconnected or grounded
3	NC	NA	DSC2110: Leave unconnected or grounded
	SCLK	I	DSC2210: Serial clock from master
4	GND	Power	Ground
5	SDA	I	DSC2110: I <sup>2</sup> C Serial Data
	MOSI		DSC2210: SPI Serial Data from Master to Slave
6	SCL	I	DSC2110: I <sup>2</sup> C Serial Clock
	MISO	O	DSC2210: SPI Serial Data from Slave to Master
7	CS_bar	I	DSC2110: I <sup>2</sup> C Chip Select (Active Low)
	SS	I	DSC2210: SPI Slave Select (Active Low)
8	Output1	O	CMOS output 1
9	NC	NA	Leave unconnected or grounded
10	NC	NA	Leave unconnected or grounded
11	NC	NA	Leave unconnected or grounded
12	VDD2	Power	Power Supply
13	VDD	Power	Power Supply
14	FS	I	Default output clock frequency bit

## Operational Description

The DSC2110/2210 is a CMOS oscillator consisting of a MEMS resonator and a support PLL IC. The CMOS output is generated through independent 8-bit programmable dividers from the output of the internal PLL.

DSC2110/2210 allows for easy programming of the output frequencies using I<sup>2</sup>C/SPI interface. Upon power-up, the initial output frequency is controlled by an internal pre-programmed memory (OTP). This memory stores all coefficients required by the PLL for two different default frequencies. The control pin (FS) selects the initial frequency. Once the device is powered up, a new output frequency can be programmed. Programming details are provided in the **Programming Guide**. Standard default frequencies are described in the following sections. Discera supports customer defined versions of the DSC2110/2210.

When Enable (pin 1) is floated or connected to VDD, the DSC2110/2210 is in operational

mode. Driving Enable to ground will disable both output drivers (hi-impedance mode).

The DSC2110/2210 has programmable output drive strength, which can be controlled via I<sup>2</sup>C/SPI. Table 1 displays typical rise / fall times for the output with a 15pf load capacitance as a function of these control bits at VDD=3.3V and room temperature.

Table 1. Rise/Fall times for drive strengths

Output Drive Strength Bits [OXS2, OXS1, OXS0] - Default [111] X=1 for output1, and 2 for output2								
	000	001	010	011	100	101	110	111
tr (ns)	2.1	1.7	1.6	1.4	1.3	1.3	1.2	1.1
tf (ns)	2.5	2.4	2.4	2	1.8	1.6	1.3	1.3

## Output Clock Frequencies

Table 2 lists the standard frequency configurations and the associated ordering information to be used in conjunction with the ordering code. Customer defined combinations are available.

Table 2. Pre-programmed pin-selectable output frequency combinations

Ordering Info	Freq (MHz)	Select Bit [FS] – <b>Default is [1]</b>	
		0	1
A0001	f <sub>OUT</sub>	27	<b>24</b>
A0002	f <sub>OUT</sub>	155.52	<b>106.25</b>
A0003	f <sub>OUT</sub>	25	<b>75</b>
A0004	f <sub>OUT</sub>	72	<b>74.25</b>
A0005	f <sub>OUT</sub>	27	<b>50</b>
A0006	f <sub>OUT</sub>	16	<b>13.56</b>
A0007	f <sub>OUT</sub>	96	<b>55</b>
A0008	f <sub>OUT</sub>	25	<b>50</b>
A0009	f <sub>OUT</sub>	55.296	<b>27.648</b>
A00010	f <sub>OUT</sub>	27.648	<b>55.296</b>
AXXXX	f <sub>OUT</sub>	Contact factory for additional configurations.	

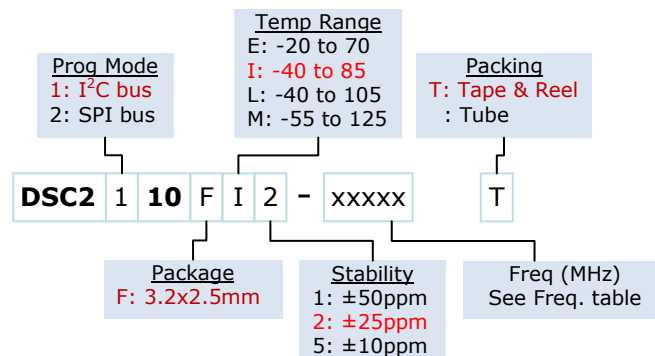
Frequency select bit are weakly tied high so if left unconnected the default setting will be [1] and the device will output the associated frequency highlighted in **Bold**.

## Absolute Maximum Ratings

Item	Min	Max	Unit	Condition
Supply Voltage	-0.3	+4.0	V	
Input Voltage	-0.3	V <sub>DD</sub> +0.3	V	
Junction Temp	-	+150	°C	
Storage Temp	-55	+150	°C	
Soldering Temp	-	+260	°C	40sec max.
ESD	-		V	
HBM		4000		
MM		400		
CDM		1500		

Note: 1000+ years of data retention on internal memory

## Ordering Code



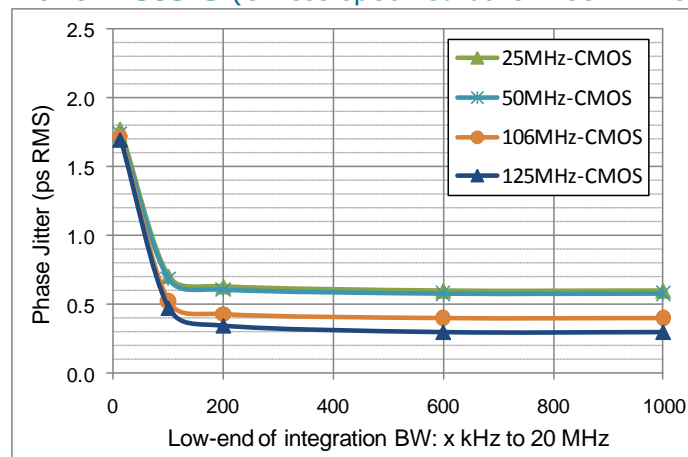
## Specifications (Unless specified otherwise: T=25° C, max CMOS drive strength)

Parameter		Condition	Min.	Typ.	Max.	Unit
Supply Voltage <sup>1</sup>	V <sub>DD</sub>		2.25		3.6	V
Supply Current	I <sub>DD</sub>	EN pin low – output is disabled		21	23	mA
Frequency Stability	Δf	Includes frequency variations due to initial tolerance, temp. and power supply voltage			±10 ±25 ±50	ppm
Aging	Δf	1 year @25°C			±5	ppm
Startup Time <sup>2</sup>	t <sub>SU</sub>	T=25°C			5	ms
Input Logic Levels						
Input logic high	V <sub>IH</sub>		0.75xV <sub>DD</sub>		-	V
Input logic low	V <sub>IL</sub>		-		0.25xV <sub>DD</sub>	
Output Disable Time <sup>3</sup>	t <sub>DA</sub>				5	ns
Output Enable Time	t <sub>EN</sub>				20	ns
Pull-Up Resistor <sup>4</sup>		Pull-up exists on all digital IO		40		kΩ
<b>CMOS Output</b>						
Supply Current <sup>4</sup>	I <sub>DD</sub>	EN pin high – output is enabled C <sub>L</sub> =15pF, F <sub>0</sub> =125 MHz		31	35	mA
Output Logic Levels						
Output logic high	V <sub>OH</sub>	I=±6mA	0.9xV <sub>DD</sub>		-	V
Output logic low	V <sub>OL</sub>		-		0.1xV <sub>DD</sub>	
Output Transition time <sup>3</sup>						
Rise Time	t <sub>R</sub>	20% to 80% C <sub>L</sub> =15pf		1.1	2	ns
Fall Time	t <sub>F</sub>			1.3	2	
Frequency	f <sub>0</sub>	Commercial/Industrial temp range Automotive temp range	2.3		170 100	MHz
Output Duty Cycle	SYM		45		55	%
Period Jitter	J <sub>PER</sub>	F <sub>0</sub> =125 MHz		3		ps <sub>RMS</sub>
Integrated Phase Noise	J <sub>CC</sub>	200kHz to 20MHz @ 125MHz 100kHz to 20MHz @ 125MHz 12kHz to 20MHz @ 125MHz		0.3 0.38 1.7	2	ps <sub>RMS</sub>

### Notes:

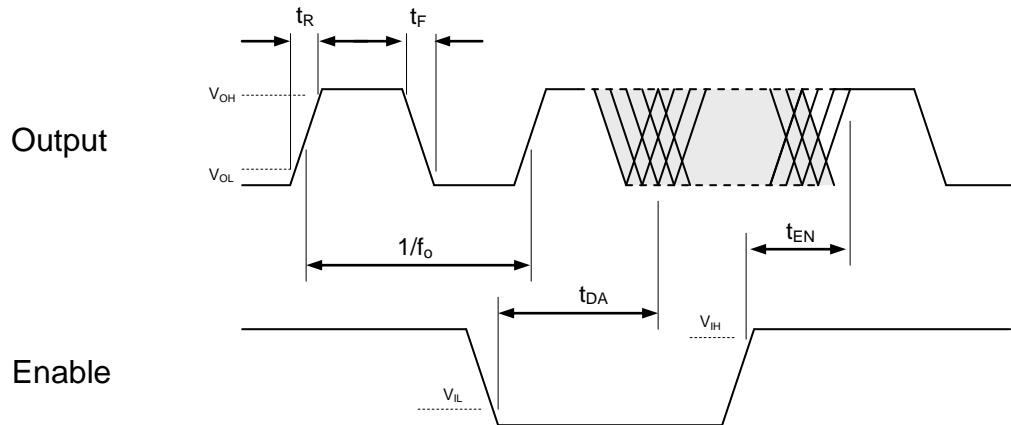
- Pin 4 V<sub>DD</sub> should be filtered with 0.01μF capacitor.
- t<sub>SU</sub> is time to 100PPM stable output frequency after V<sub>DD</sub> is applied and outputs are enabled.
- Output Waveform and Test Circuit figures below define the parameters.
- Output is enabled if Enable pad is floated or not connected.

## Nominal Performance Parameters (Unless specified otherwise: T=25° C, V<sub>DD</sub>=3.3 V)

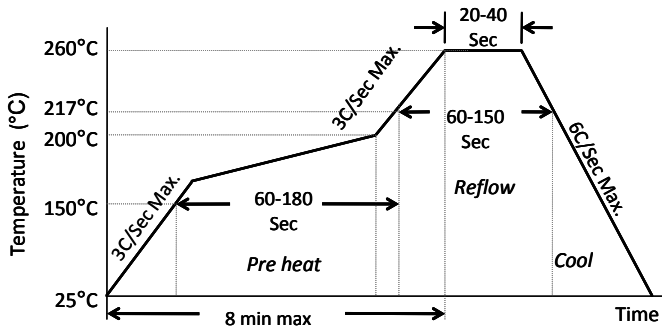


CMOS Phase jitter (integrated phase noise)

## Output Waveform: CMOS



## Solder Reflow Profile



### MSL 1 @ 260°C refer to JSTD-020C

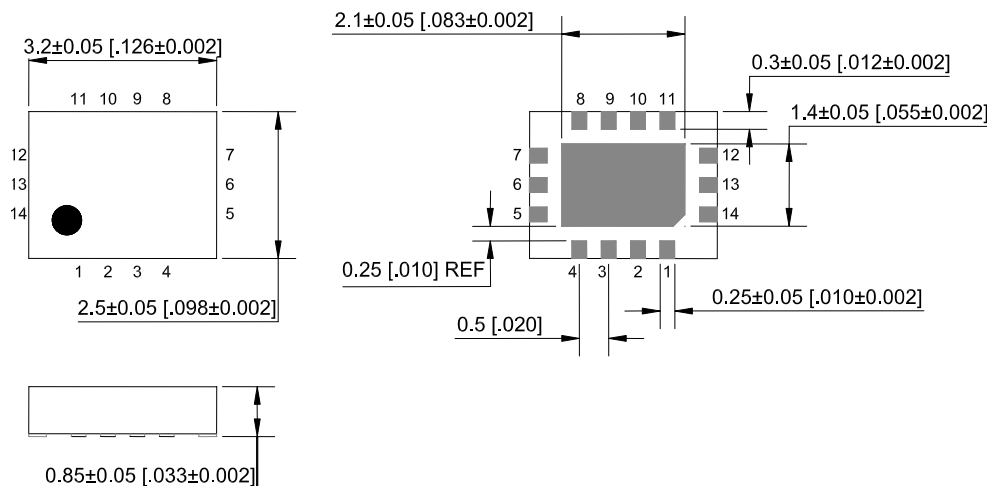
Ramp-Up Rate (200°C to Peak Temp)	3°C/Sec Max.
Preheat Time 150°C to 200°C	60-180 Sec
Time maintained above 217°C	60-150 Sec
Peak Temperature	255-260°C
Time within 5°C of actual Peak	20-40 Sec
Ramp-Down Rate	6°C/Sec Max.
Time 25°C to Peak Temperature	8 min Max.

## Package Dimensions

### 3.2 x 2.5 mm 14 Lead Plastic Package

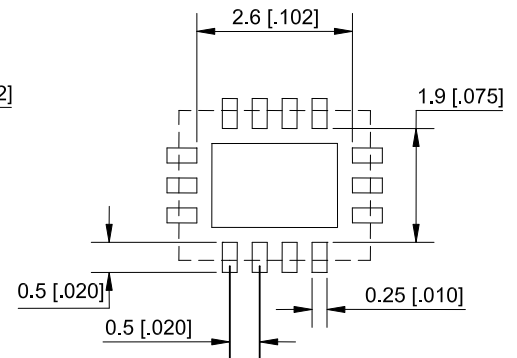
#### External Dimensions

units: mm[inch]



#### Recommended Solder Pad Layout

units: mm[inch]



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